Supplementary Information

Ultrafast Switching and Linear Conductance Modulation in Ferroelectric Tunnel Junctions via P(VDF-TrFE) Morphology Control

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S1. Atomic-force microscopy (AFM)



Fig. S1 | Thickness of the P(VDF-TrFE) layer measured with AFM on the prepared step-edges of the sample.

S2. Piezo-force microscopy (PFM)



Fig. S2 | Local PFM hysteresis loops of a 6-nm-thick P(VDF-TrFE) film on a 1% Nb-doped $SrTiO_3$ substrate. The red and blue curves indicate change in phase and amplitude upon sweeping the voltage from positive to negative and reverse direction, respectively.

S3. Switching reproducibility and device-to-device variation



Fig. S3 | **a**, Analog resistance switching in a typical P(VDF-TrFE) based FTJ memristor - multiple, stable resistance states can be obtained by complete or partial rotation of ferroelectric domains when the devices are subjected to varying range of sweeping voltages. **b**, Reproducibility of consecutive switching between the high- and low-resistance states and four other intermediate resistance levels. It was found that higher current levels are extremely reproducible while the lower current states show certain randomness over cycle to cycle. **c**,**d**, Device-to-device variation

of the high- and low-resistance states (c) and switching voltage (d) for 20 FTJ memristors on the same sample. No significant variation in samples from batch-to-batch was found.